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APPLICATION NO.	ı ı	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/811,999		03/30/2004	Kenichi Shirasaka	X2007.0158	2679
32172	7590	06/29/2006	EXAMINER		
		IRO MORIN & O	PIZARRO CRES	PO, MARCOS D	
11// AVEN 41 ST FL.	UE OF I	HE AMERICAS (6T	H AVENUE)	ART UNIT	PAPER NUMBER
NEW YOR	, NY 10036-2714			2814	

DATE MAILED: 06/29/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)				
Office Action Occur		10/811,999	SHIRASAKA, KENICHI				
	Office Action Summary	Examiner	Art Unit				
		Marcos D. Pizarro-Crespo	2814				
Period fo	The MAILING DATE of this communication ap or Reply	opears on the cover sheet with the c	orrespondence address				
WHIC - Exte after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REP CHEVER IS LONGER, FROM THE MAILING I nsions of time may be available under the provisions of 37 CFR 1 SIX (6) MONTHS from the mailing date of this communication. of period for reply is specified above, the maximum statutory period tre to reply within the set or extended period for reply will, by statuted treply received by the Office later than three months after the mailined patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICATION .136(a). In no event, however, may a reply be tind d will apply and will expire SIX (6) MONTHS from the, cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).				
Status							
1) 🖂	Responsive to communication(s) filed on 30	May 2006.					
·	This action is FINAL . 2b)⊠ This action is non-final.						
3) 🗌							
	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Dispositi	ion of Claims						
4)⊠	4)⊠ Claim(s) <u>1-12</u> is/are pending in the application.						
•	4a) Of the above claim(s) <u>1,2,4-9 and 11</u> is/are withdrawn from consideration.						
5) 🗌) ☐ Claim(s) is/are allowed.						
6)⊠	☐ Claim(s) <u>3,10 and 12</u> is/are rejected.						
7)							
8)⊠	Claim(s) <u>1-12</u> are subject to restriction and/or	r election requirement.					
Applicati	ion Papers						
9)	The specification is objected to by the Examin	ner.					
10)⊠	10)⊠ The drawing(s) filed on <u>30 May 2006</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.						
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
	Replacement drawing sheet(s) including the corre	ction is required if the drawing(s) is ob	jected to. See 37 CFR 1.121(d).				
11)	The oath or declaration is objected to by the E	Examiner. Note the attached Office	Action or form PTO-152.				
Priority ι	ınder 35 U.S.C. § 119						
a)l	Acknowledgment is made of a claim for foreig All b) Some * c) None of: 1. Certified copies of the priority documer 2. Certified copies of the priority documer 3. Copies of the certified copies of the pri application from the International Bures See the attached detailed Office action for a list	nts have been received. nts have been received in Applicati ority documents have been receive au (PCT Rule 17.2(a)).	ion No ed in this National Stage				
2) 🔲 Notic 3) 🔯 Infori	t(s) se of References Cited (PTO-892) se of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08 r No(s)/Mail Date <u>3/10/2006</u> .	4) Interview Summary Paper No(s)/Mail Do 5) Notice of Informal F 6) Other:					

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Attorney's Docket Number: X2007.0158

Filing Date: 3/30/2004

Claimed Foreign Priority Date: 4/2/2003 (JP 2003-099126)

Applicant(s): Shirasaka

Examiner: Marcos D. Pizarro-Crespo

DETAILED ACTION

This Office action responds to the amendment filed on 5/30/2006.

Acknowledgment

1. The amendment filed on 5/30/2006, responding to the Office action mailed on 11/28/2005, has been entered. The present Office action is made with all the suggested amendments being fully considered. Accordingly, pending in this Office action are claims 1-12.

Drawings

2. The drawings received on 5/30/2006 are accepted.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 3, 10, and 12 are rejected under 35 U.S.C. 103(a) as being unpatentable over Frezza (US 6909166) in view of Harper.

- 5. Regarding claims 10 and 12, Frezza (see, *e.g.*, fig. 9 and 10) teaches a manufacturing method for a semiconductor package comprising the steps of:
 - ✓ Forming a lead frame by processing a thin plate (see, e.g., col.4/ll.63-67), wherein the lead frame comprises:
 - A stage 70 for mounting a semiconductor chip 12 thereon
 - A plurality of groups of leads 71 arranged in a periphery of the stage 70
 - A plurality of lead interconnection members for interconnecting a plurality
 of leads in each of the group of leads (see, e.g., fig. 9)
 - ✓ Mounting the chip on the stage of the lead frame via bonding (see, e.g., fig. 2)
 - ✓ Wiring the chip to the plurality of leads (see, e.g., fig. 2)
 - ✓ Forming a molded resin **61** for integrally fixing the chip, the stage, and the leads therein, the molded resin having side surfaces **36** around a periphery **37** thereof (see, *e.g.*, figs. 2, 7 and 10)
 - ✓ Plating prescribed surfaces of the leads that are exposed to an exterior of the resin (see, e.g., col.5/II.41-42)
 - ✓ Cutting the leads **71** at a plurality of cutting lines **34** so that the leads **71** are made electrically independent of each other (see, *e.g.*, figs. 9 and 10), and so that the plurality of leads do not extend beyond side surfaces **37** of the molded resin (see, *e.g.*, col.5/II.56-58)

Wherein:

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- ✓ A through hole is formed in each lead in a thickness direction of the lead frame so as to allow the cutting lines to pass therethrough (see, e.g., figs. 9 and 10)
- ✓ The through holes are formed at a selected timing within a prescribed time period counting from a timing of forming the lead frame to a timing of plating the leads (see, e.g., col.5/II.45)

Frezza, however, fails to specify that the lead frame be made of metal. Harper (see, e.g., pp.6.18/par.3), on the other hand, teaches that leadframes are usually made of a copper alloy for better thermal performance.

It would have been obvious at the time of the invention to one of ordinary skill in the art to have Frezza's lead frame made of the metal suggested by Harper for better thermal performance.

6. Regarding claim 10, Frezza shows the through holes are formed by etching (see, e.g., col.5/II.45).

Response to Arguments

7. The applicants argue:

The independent claims now require that the plurality of leads do not extend beyond the side surface of the molded resin. Neither Frezza nor Harper teach or suggest this limitation of the present invention. For example, all of the leads in Frezza extend beyond its molded resin as illustrated in figures 7, 8, 9, 12, and 13.

The examiner responds:

Although figures 7, 8, 12, and 13 of Frezza show the leads extending beyond the side surface of the resin, that is not the case of the embodiment of figures 9 and 10. As Frezza describes, the leads of figures 9 and 10 have their side surfaces **36** in the

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perimetric zones **37** encapsulated by the resin **60** while their side surfaces **36** in the etching zone **39** is exposed for plating (see, e.g., col.5/II.41-46, 56-60).

Conclusion

- 8. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).
- 9. A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.
- 10. Papers related to this application may be submitted directly to Art Unit 2814 by facsimile transmission. Papers should be faxed to Art Unit 2814 via the Art Unit 2814 Fax Center. The faxing of such papers must conform to the notice published in the Official Gazette, 1096 OG 30 (15 November 1989). The Art Unit 2814 Fax Center number is (571) 273-8300. The Art Unit 2814 Fax Center is to be used only for papers related to Art Unit 2814 applications.
- 11. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Marcos D. Pizarro-Crespo at (571) 272-1716 and between the hours of 10:00 AM to 8:30 PM (Eastern Standard Time) Monday through

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Thursday or by e-mail via Marcos.Pizarro@uspto.gov. If attempts to reach the

examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy, can

be reached on (571) 272-1705.

12. Any inquiry of a general nature or relating to the status of this application may be

obtained from the Patent Application Information Retrieval (PAIR) system. Status

information for published applications may be obtained from either Private PAIR or

Public PAIR. Status information for unpublished applications is available through

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automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-

1000.

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13. The following list is the Examiner's field of search for the present Office Action:

Field of Search	Date
U.S. Class / Subclass(es): 257/666-796	6/23/2006
Other Documentation:	
Electronic Database(s): EAST (USPAT, EPO, JPO)	6/23/2006

Marcos D. Pizarro-Crespo

Patent Examine Art Unit 2814

571-272-1716

marcos.pizarro@uspto.gov

MDP/mdp June 23, 2006